Thru-Hole Tuning Fork



Model: NC15LF/NC26LF/NC38LF

RoHS Compliant / pB Free

Rev. 1/13/2012

http://www.foxonline.com/need_a_sample.htm

Need a Sample®

FEATURES

- · Miniature Packages
- Low Cost
- Cold Weld Design
- · Long Term Stability
- Tight Tolerance

Click to view mounting precautions

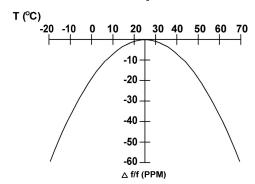
PART NUMBER SELECTION Learn More - Internet Required					
Part Number	Model Number	Frequency Stability	Operating Temperature	Frequency	
298LF-Frequency-xxxxx	NC15LF	-0.04 PPM / (Δ°C) ²	-20 °C~ +60 °C	32.768 kHz	
299LF-Frequency-xxxxx	NC26LF	-0.04 PPM / (∆°C) ²	-20 °C~ +60 °C	32.768 kHz	
300LF-Frequency-xxxxx	NC38LF	-0.04 PPM / (Δ°C) ²	-20 °C~ +60 °C	32.768 kHz	

STANDARD SPECIFICATIONS				
PARAMETERS	MAX (unless otherwise noted)			
Frequency		32.768 kHz		
Frequency Tolerance @ 25°C		± 20 PPM		
Frequency Stability				
Temperature Coefficient		-0.04 PPM / (Δ°C) ²		
Temperature Range				
Turnover (T	0)	+20°C ~ +30°C		
Operating (T	OPR)	-20°C ~ +60°C		
Storage (T	STG)	-30°C ~ +70°C		
Equivalent Series Resistance (Rs)				
NC15 / NC26		50 kΩ		
NC38		35 kΩ		
Load Capacitance (C	EL)	12.5 pF (Standard)		
		6 pF (Optional)		
Insulation Resistance @ 100VDC		500 MΩ Min		
Drive Level	1.0 µW			
Aging per year	±3 PPM			

All specifications subject to change without notice.

Note: Can should not be soldered to the circuit board or grounded. If securing the can to the board is desired, a rubber adhesive is recommended.

Parabolic Temperature Curve

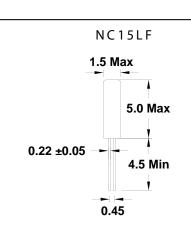


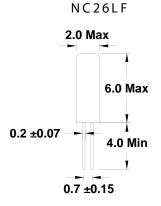
To determine frequency stability, use parabolic curvature (K). For example: What is stability at 45 °C?

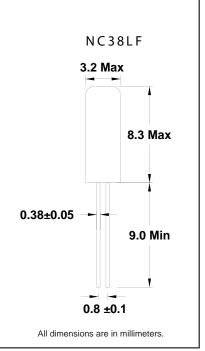
1) Change in T (°C) = 45-25 = 20°C

2) Change in frequency = -0.04 PPM * $(\triangle C)^2$ = -0.04 PPM * $(20)^2$

= -16.0 PPM







5570 Enterprise Parkway Fort Myers, FL. 33905 Tel: 239.693.0099 Fax: 239.693.1554 Contact us at Foxonline.com

Canada EMEA Asia Singapore Japan

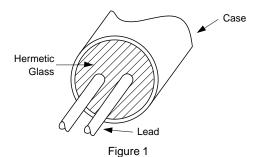
Tel: 239.464.2501 Tel: +44.1283.568153 Tel: +852.2854.4285 Tel: +65.6844798 Tel: +81.3.3374.2079

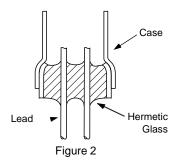
1. Mounting Precautions

1.1 Lead Type Crystal Units

1.1.1. Structure

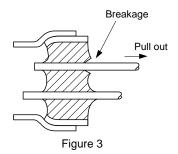
Tubular crystal units are hermetically sealed using glass (see Figures 1 and 2).

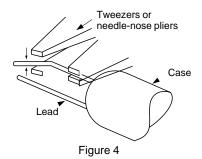




1.1.2 Unbending the lead

- (1) DO NOT pull the lead excessively if unbending a lead or removing a crystal unit. The excessive force may crack the glass and reduce the degree of vacuum. This may eventually result in deterioration of the characteristics and may also break the crystal chip see Figure 3).
- (2) Unbend the lead by pressing on the bent part from both the upper and lower sides with fixing the bottom of lead tightly. (see Figure 4).





1.1.3 Bending the lead

- (1) Bend the lead so that the lead will remain straight for more than 0.5mm from the case when soldering a crystal unit after bending. If not, the glass may be cracked (see Figures 5 and 6).
- (2) Always leave a length greater than the case diameter when bending a lead after soldering (see Figure 7).

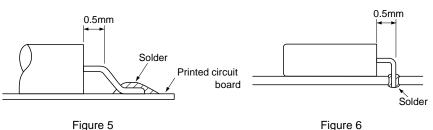


Figure 6

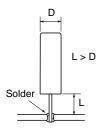


Figure 7

Soldering directly to the case will reduce the degree of vacuum and may result in deterioration of the characteristics and may break the crystal chip.

Make the length from the case to the printed circuit board (L) longer than the case diameter (D) so that the lead wire will not be pulled in case the crystal unit falls over.

1.1.4 Soldering

When mounting or removing a quartz crystal unit, heat the lead part at 300°C or lower for 5 seconds or less (in the case of a lead-type conventional product). A long period of time of heating may result in deterioration of the characteristics and may break the crystal unit. Be sure to keep the case at or below 150°C.